MOSFET - SiC Power, Single N-Channel, TO247-4L 1200 V, 40 mΩ, 58 A

NVH4L040N120SC1

Features

- Typ. $R_{DS(on)} = 40 \text{ m}\Omega$
- Ultra Low Gate Charge $(Q_{G(tot)} = 106 \text{ nC})$
- High Speed Switching with Low Capacitance (Coss = 137 pF)
- 100% Avalanche Tested
- AEC-Q101 Qualified and PPAP Capable
- This Device is Pb-Free and is RoHS Compliant

Typical Applications

- Automotive On Board Charger
- Automotive DC/DC Converter for EV/HEV

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	1200	V
Gate-to-Source Voltage			V_{GS}	-15/+25	V
Recommended Operation Values of Gate-to-Source Voltage		V_{GSop}	-5/+20	V	
Continuous Drain Current (Note 2)	Steady State	T _C = 25°C	I _D	58	Α
Power Dissipation (Note 2)			P _D	319	W
Continuous Drain Current (Notes 1, 2)	Steady State	T _C = 100°C	I _D	41	Α
Power Dissipation (Notes 1, 2)			P _D	160	W
Pulsed Drain Current (Note 3)	T _A = 25°C		I _{DM}	232	Α
Single Pulse Surge Drain Current Capability	T_C = 25°C, t_p = 10 μ s, R_G = 4.7 Ω		I _{DSC}	416	Α
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +175	ç
Source Current (Body Diode)			IS	32	Α
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 34 A, L = 1 mH) (Note 4)			E _{AS}	578	mJ
Maximum Lead Temperature for Soldering (1/8" from case for 5 s)			TL	300	ç

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- JA is constant value to follow guide table of LV/HV discrete final datasheet generation.
- generation.

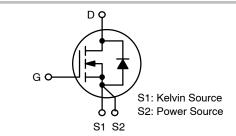
 2. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 3. Repetitive rating, limited by max junction temperature.
- 4. EAS of 578 mJ is based on starting $T_J = 25^{\circ}C$; L = 1 mH, $I_{AS} = 34$ A, $V_{DD} = 120$ V, $V_{GS} = 20$ V.



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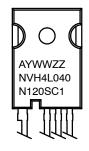
V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
1200 V	56 mΩ @ 20 V	58 A



N-CHANNEL MOSFET



MARKING DIAGRAM



A = Assembly Location

Y = Year WW = Work Week ZZ = Lot Traceability

NVH4L040N120SC1 = Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping	
NVH4L040N120SC1	TO247-4L	30 ea / Tube	

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Case - Steady State (Note 2)		0.47	°C/W
Junction-to-Ambient - Steady State (Notes 1, 2)	$R_{\theta JA}$	40	

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

V _{(BR)DSS} V _{(BR)DSS} /T _J				-		
+	V 0V 1 4 A					
V _{(BB)DSS} /T ₁	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	V _{GS} = 0 V, I _D = 1 mA		-	_	V
(511)255, 1	I _D = 1 mA, referenced to 25°C		-	0.45	-	V/°C
I _{DSS}	$V_{GS} = 0 \text{ V},$ $T_{J} = 25^{\circ}\text{C}$		-	-	100	μΑ
	V _{DS} = 1200 V	T _J = 175°C	-	-	1	mA
I _{GSS}	$V_{GS} = +25/-15 \text{ V}, V_{D}$	_S = 0 V	-	-	±1	μΑ
•						
V _{GS(TH)}	$V_{GS} = V_{DS}, I_{D} = 10 \text{ m}$	A	1.8	3.0	4.3	V
V_{GOP}			-5	-	+20	V
R _{DS(on)}	V _{GS} = 20 V, I _D = 35 A, T _J = 25°C V _{GS} = 20 V, I _D = 35 A, T _J = 175°C		-	40	56	mΩ
			-	70	100	
9FS	V _{DS} = 20 V, I _D = 35 A		-	20	-	S
SISTANCE					J	
C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 800 V		-	1762	-	pF
C _{OSS}			-	137	-	
C _{RSS}			-	11	-	
Q _{G(TOT)}	$V_{GS} = -5/20 \text{ V}, V_{DS} = 600 \text{ V},$ $I_{D} = 47 \text{ A}$		-	106	-	nC
Q _{G(TH)}			-	16	-	
Q _{GS}			-	34	-	
Q_{GD}			-	26	-	
R _G	f = 1 MHz		-	2.4	-	Ω
10 V					J	
t _{d(ON)}	$V_{GS} = -5/20 \text{ V},$		-	17	30	ns
t _r			-	20	36	
t _{d(OFF)}	$R_G = 4.7 \Omega$ inductive load		_	32	51	
t _f			-	10	20	
E _{ON}			-	411	-	μJ
E _{OFF}			-	205	-	
E _{tot}			-	616	-	
TICS						
I _{SD}	$V_{GS} = -5 \text{ V}, T_{J} = 25^{\circ}\text{C}$		-	-	32	Α
I _{SDM}			-	-	232	
V _{SD}	V _{GS} = -5 V, I _{SD} = 17. 25°C	5 A, T _J =	-	3.7	-	V
	I _{GSS}	$V_{DS} = 1200 \text{ V}$ $I_{GSS} \qquad V_{GS} = +25/-15 \text{ V}, V_{D}$ $V_{GS}(TH) \qquad V_{GS} = V_{DS}, I_{D} = 10 \text{ m}$ $V_{GOP} \qquad V_{GS} = 20 \text{ V}, I_{D} = 35 \text{ A}$ $V_{GS} = 20 \text{ V}, I_{D} = 35 \text{ A}$ $V_{DS} = 20 \text{ V}, I_{D} = 35 \text{ A}$ $V_{DS} = 20 \text{ V}, I_{D} = 35 \text{ A}$ $V_{DS} = 20 \text{ V}, I_{D} = 35 \text{ A}$ $V_{DS} = 20 \text{ V}, I_{D} = 35 \text{ A}$ $V_{DS} = 20 \text{ V}, I_{D} = 35 \text{ A}$ $V_{DS} = 20 \text{ V}, I_{D} = 35 \text{ A}$ $V_{DS} = 20 \text{ V}, I_{D} = 35 \text{ A}$ $V_{DS} = 20 \text{ V}, I_{D} = 35 \text{ A}$ $V_{DS} = 20 \text{ V}, I_{D} = 35 \text{ A}$ $V_{DS} = 20 \text{ V}, I_{D} = 35 \text{ A}$ $V_{DS} = 20 \text{ V}, I_{D} = 35 \text{ A}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$ $V_{DS} = -5/20 \text{ V}, V_{DS} = -5/20 \text{ V}$	$ V_{DS} = 1200 \text{ V} T_{J} = 175^{\circ}\text{C} $ $ I_{GSS} V_{GS} = +25/-15 \text{ V}, V_{DS} = 0 \text{ V} $ $ V_{GS}(TH) V_{GS} = V_{DS}, I_{D} = 10 \text{ mA} $ $ V_{GOP} $	$V_{DS} = 1200 \ V$ $I_{GSS} V_{GS} = +25/-15 \ V, V_{DS} = 0 \ V$ $V_{GS}(TH) V_{GS} = V_{DS}, I_{D} = 10 \ mA$ $V_{GOP} I_{DS}(0n) V_{GS} = 20 \ V, I_{D} = 35 \ A, T_{J} = 25^{\circ}C I_{DS} I_{DS} = 20 \ V, I_{D} = 35 \ A, T_{J} = 175^{\circ}C I_{DS} I_{DS} = 20 \ V, I_{D} = 35 \ A, T_{J} = 175^{\circ}C I_{DS} I_{DS} = 20 \ V, I_{D} = 35 \ A I_{DS} = 20 \ V, I_{D} = 35 \ A I_{DS} = 20 \ V, I_{DS} = 800 \ V_{DS} I_{DS} = 20 \ V, I_{DS} = 800 \ V_{DS} I_{DS} = 47 \ A I_{DS} I_{DS} I_{DS} I_{DS} = 47 \ A I_{DS} $	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{ c c c c c c } \hline V_{DS} = 1200 V & \hline T_J = 175^\circ C & - & - & 1 \\ \hline I_{GSS} & V_{GS} = +25/-15 V, V_{DS} = 0 V & - & - & \pm 1 \\ \hline \hline V_{GS(TH)} & V_{GS} = V_{DS}, I_D = 10 \text{mA} & 1.8 & 3.0 & 4.3 \\ \hline V_{GOP} & -5 & - & +20 \\ \hline R_{DS(on)} & V_{GS} = 20 V, I_D = 35 A, T_J = 25^\circ C & - & 40 & 56 \\ \hline V_{GS} = 20 V, I_D = 35 A, T_J = 175^\circ C & - & 70 & 100 \\ \hline g_{FS} & V_{DS} = 20 V, I_D = 35 A, T_J = 175^\circ C & - & 70 & 100 \\ \hline g_{FS} & V_{DS} = 20 V, I_D = 35 A, T_J = 175^\circ C & - & 70 & 100 \\ \hline g_{FS} & V_{DS} = 20 V, I_D = 35 A, T_J = 175^\circ C & - & 70 & 100 \\ \hline g_{FS} & V_{DS} = 20 V, I_D = 35 A, T_J = 175^\circ C & - & 70 & 100 \\ \hline g_{FS} & V_{DS} = 20 V, I_D = 35 A, T_J = 175^\circ C & - & 70 & 100 \\ \hline g_{FS} & V_{DS} = 20 V, I_D = 35 A, T_J = 105^\circ C & - & 100 & - \\ \hline C_{OSS} & - & - & 117 & - & - \\ \hline C_{OSS} & - & - & - & 117 & - & - \\ \hline C_{OSS} & - & - & - & - & 117 & - \\ \hline C_{OSS} & - & - & - & - & 106 & - \\ \hline C_{RS} & - & - & - & - & - & 106 & - \\ \hline C_{RS} & - & - & - & - & - & - & - \\ \hline C_{OSS} & - & - & - & - & - & - & - \\ \hline C_{OSS} & - & - & - & - & - & - & - & - \\ \hline C_{OSS} & - & - & - & - & - & - & - & - \\ \hline C_{OSS} & - & - & - & - & - & - & - & - \\ \hline C_{OSS} & - & - & - & - & - & - & - & - \\ \hline C_{OSS} & - & - & - & - & - & - & - & - \\ \hline C_{OSS} & - & - & - & - & - & - & - & - & - \\ \hline C_{OSS} & - & - & - & - & - & - & - & - & - \\ \hline C_{OSS} & - & - & - & - & - & - & - & - & - \\ \hline C_{OSS} & - & - & - & - & - & - & - & - & - \\ \hline C_{OS} & - & - & - & - & - & - & - & - & - & $

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified) (continued)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
DRAIN-SOURCE DIODE CHARACTERISTICS							
Reverse Recovery Time	t _{RR}	$V_{GS} = -5/20 \text{ V}, I_{SD} = 47 \text{ A},$	-	24	-	ns	
Reverse Recovery Charge	Q_{RR}	dl _S /dt = 1000 A/μs	-	124.8	-	nC	
Reverse Recovery Energy	E _{REC}		-	8.4	-	μJ	
Peak Reverse Recovery Current	I _{RRM}		-	10.4	-	Α	
Charge time	Ta	1	-	12.4	-	ns	
Discharge time	Tb	7	-	11.6	-	ns	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS

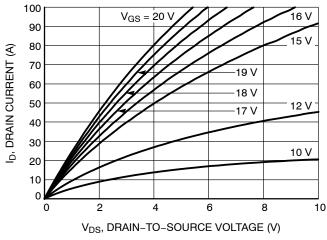


Figure 1. On-Region Characteristics

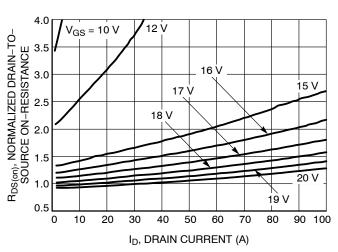


Figure 2. Normalized On-Resistance vs. Drain Current and Gate Voltage

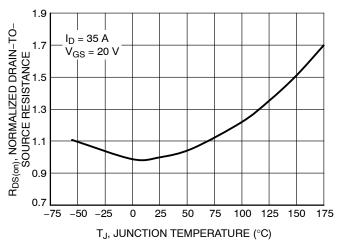


Figure 3. On–Resistance Variation with Temperature

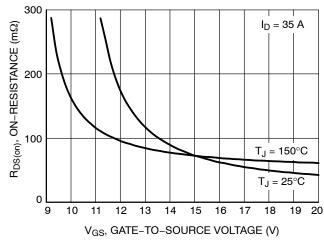


Figure 4. On-Resistance vs. Gate-to-Source Voltage

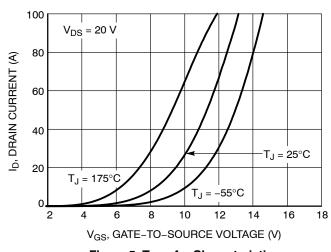


Figure 5. Transfer Characteristics

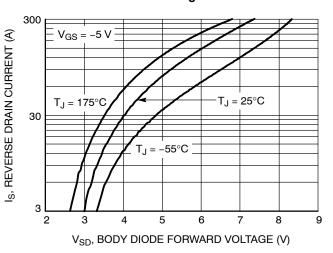


Figure 6. Diode Forward Voltage vs. Current

TYPICAL CHARACTERISTICS

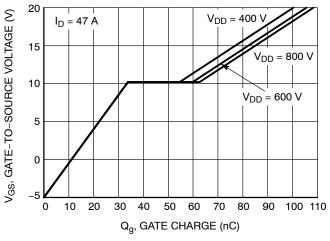


Figure 7. Gate-to-Source Voltage vs. Total Charge

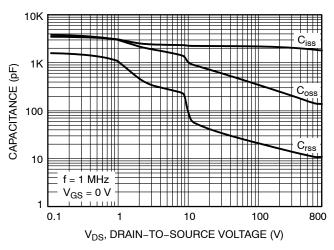


Figure 8. Capacitance vs. Drain-to-Source Voltage

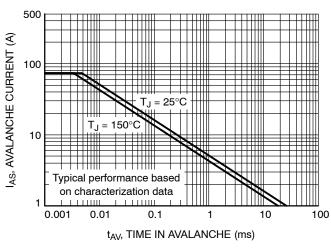


Figure 9. Unclamped Inductive Switching Capability

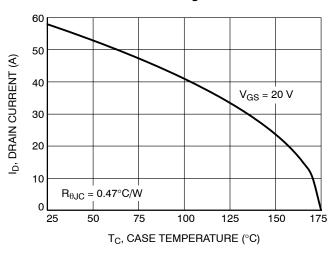


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

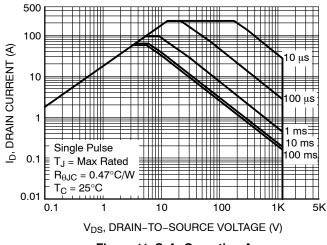


Figure 11. Safe Operating Area

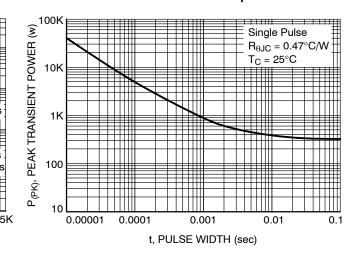


Figure 12. Single Pulse Maximum Power Dissipation

TYPICAL CHARACTERISTICS

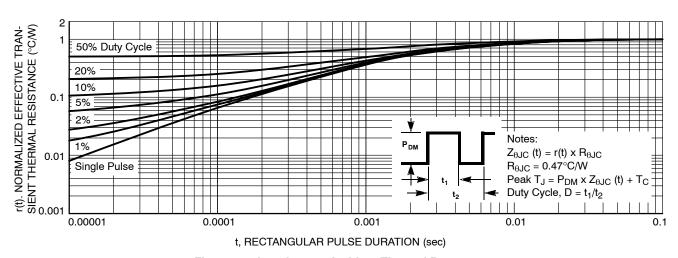
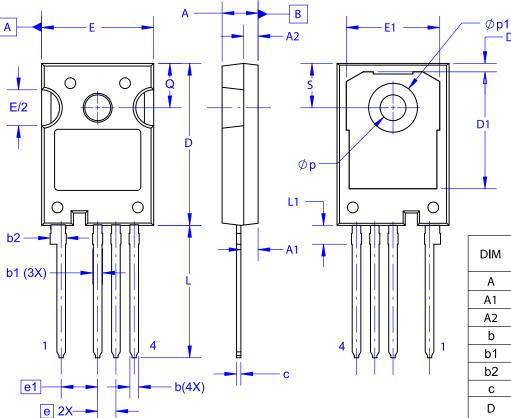


Figure 13. Junction-to-Ambient Thermal Response

TO-247-4LD CASE 340CJ **ISSUE A**

DATE 16 SEP 2019

D2



NOTES:

0.254 M

- A. NO INDUSTRY STANDARD APPLIES TO THIS PACKAGE.
 B. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD
 FLASH, AND TIE BAR EXTRUSIONS.
 C. ALL DIMENSIONS ARE IN MILLIMETERS.

C. ALL DIMENSIONS ARE IN MILLIMETERS.
D. DRAWING CONFORMS TO ASME Y14.5-2009.

DIM	WILLIMETERS				
DIM	MIN	NOM	MAX		
Α	4.80	5.00	5.20		
A1	2.10	2.40	2.70		
A2	1.80	2.00	2.20		
b	1.07	1.20	1.33		
b1	1.20	1.40	1.60		
b2	2.02	2.22	2.42		
С	0.50	0.60	0.70		
D	22.34	22.54	22.74		
D1	16.00	16.25	16.50		
D2	0.97	1.17	1.37		
е	2.54 BSC				
e1	5.08 BSC				
E	15.40	15.60	15.80		
E1	12.80	13.00	13.20		
E/2	4.80	5.00	5.20		
L	18.22	18.42	18.62		
L1	2.42	2.62	2.82		
р	3.40	3.60	3.80		
p1	6.60	6.80	7.00		
Q	5.97	6.17	6.37		
S	5.97	6.17	6.37		

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